

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	6.4mΩ@10V	90A
	8.4mΩ@4.5V	

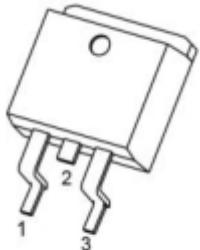
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

Application

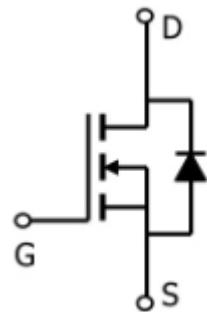
- Power switching application
- DC-DC Converter
- Power Management

Package

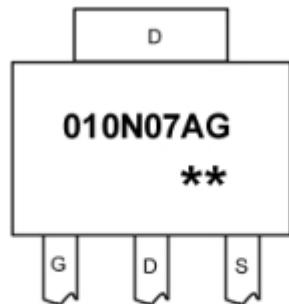


TO-263(G:1 D:2 S:3)

Circuit diagram



Marking



010N07AG : Product code
** : Week code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_c = 25^\circ\text{C}$)	I_D	90	A
Pulsed Drain Current ²	I_{DM}	360	A
Power Dissipation($T_c = 25^\circ\text{C}$)	P_D	130	W
Single Pulse Avalanche Energy ¹	E_{AS}	358	mJ
Thermal Resistance Junction-Case	$R_{\theta JC}$	0.96	$^\circ\text{C}/\text{W}$
Operation and storage temperature	T_{STG}, T_J	-55~ +150	$^\circ\text{C}$



ZL MOSFET

ZL010N07AG

Electrical characteristics

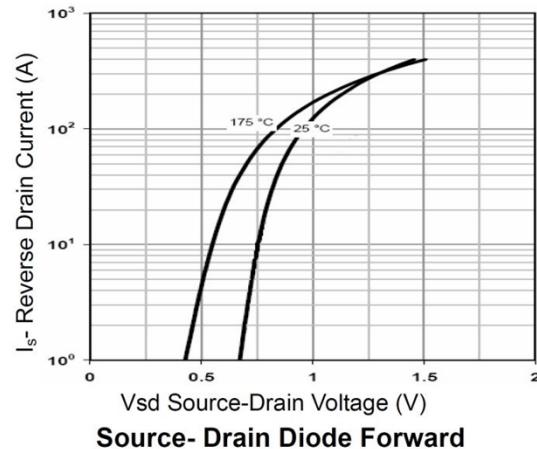
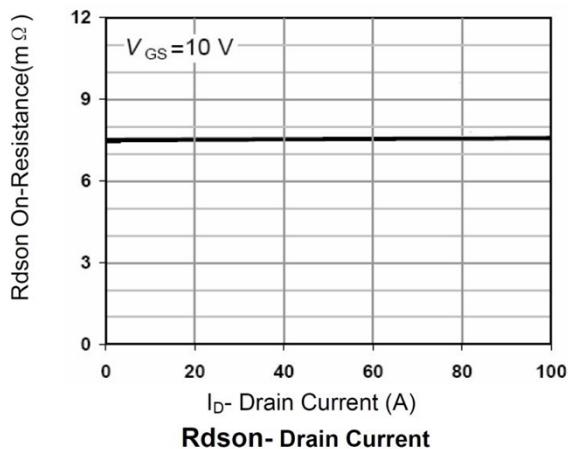
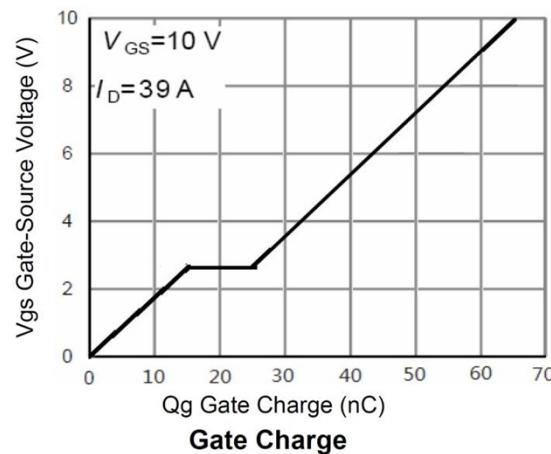
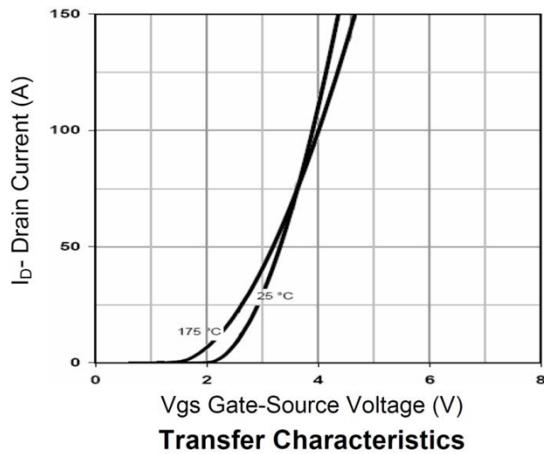
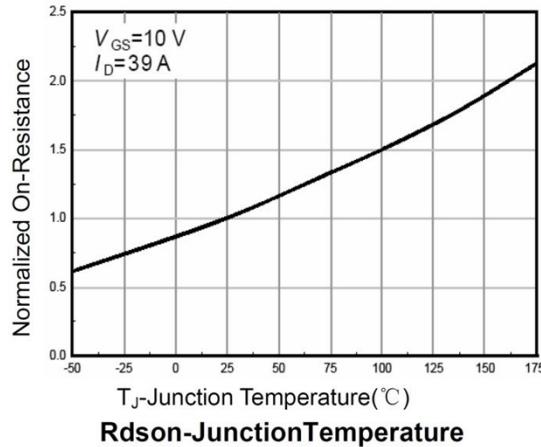
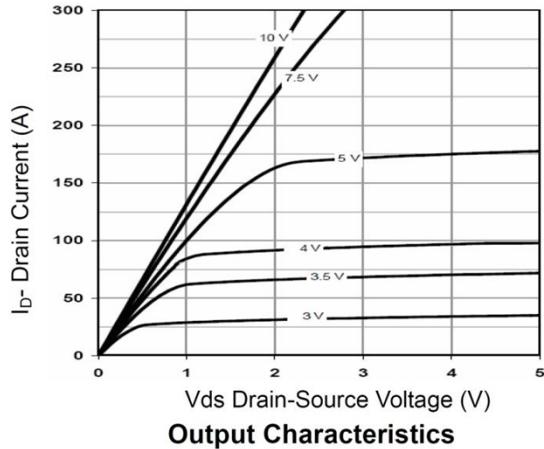
(T_A=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250μA	100			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} = 80V, V _{GS} = 0V			1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±0.1	uA
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1	1.7	2.5	V
Drain-Source on-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 30A		6.4	8	mΩ
		V _{GS} = 4.5V, I _D = 25A		8.4	11.5	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V, f=1MHz		1942		pF
Output Capacitance	C _{oss}			388		
Reverse Transfer Capacitance	C _{rss}			12		
Switching Characteristics						
Total Gate Charge (4.5V)	Q _g	V _{DS} =50V, V _{GS} =10V, I _D =30A		67		nC
Gate-Source Charge	Q _{gs}			12		
Gate-Drain Charge	Q _{gd}			21		
Turn-On Delay Time	T _{d(on)}	V _{GS} =10V, V _{DS} =50V, R _L =2.5Ω, R _G =6Ω		12		nS
Rise Time	T _r			11		
Turn-Off Delay Time	T _{d(off)}			42		
Fall Time	T _f			6		
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1A			1.2	V

Notes:

1 E AS is tested at starting T_j = 25°C, V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_g = 25 mΩ;

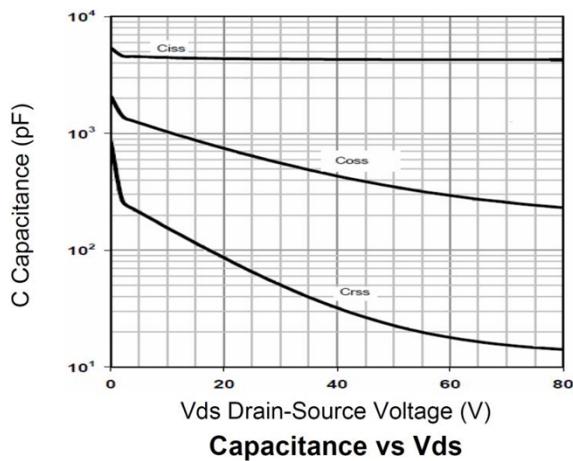
Typical Characteristics



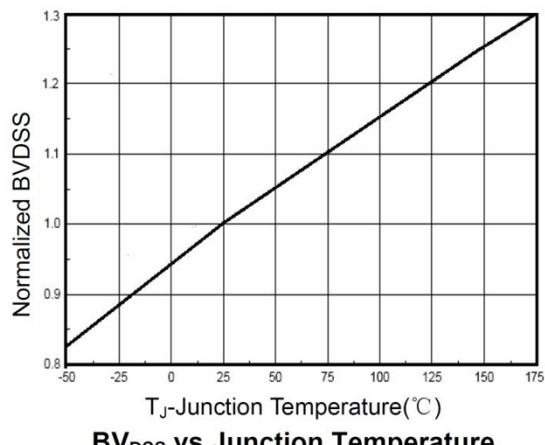


ZL MOSFET

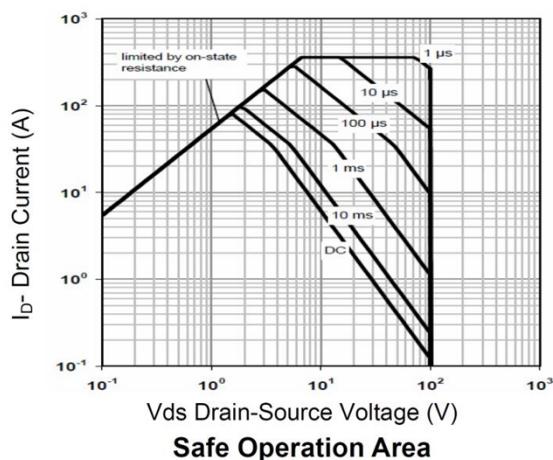
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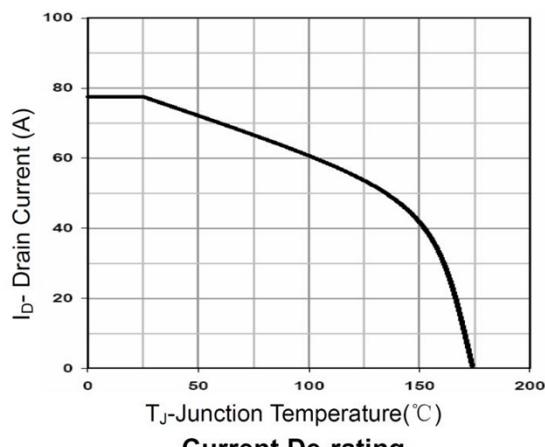
Capacitance vs V_{DS}



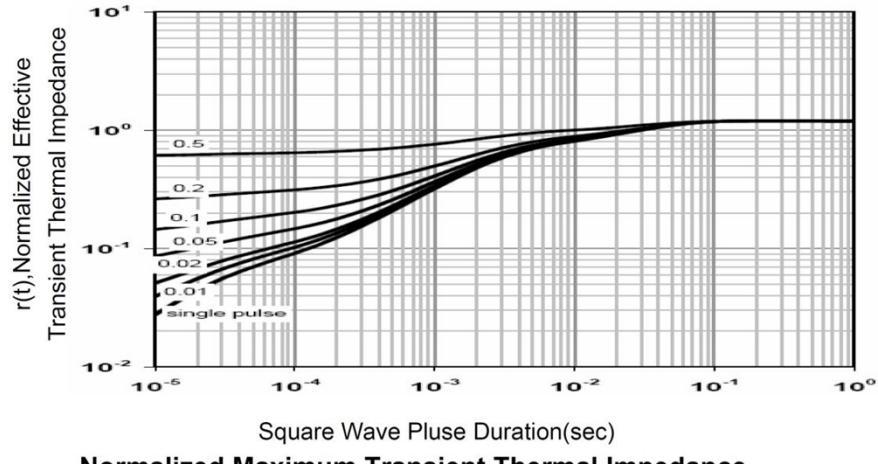
BV_{DSS} vs Junction Temperature



Safe Operation Area

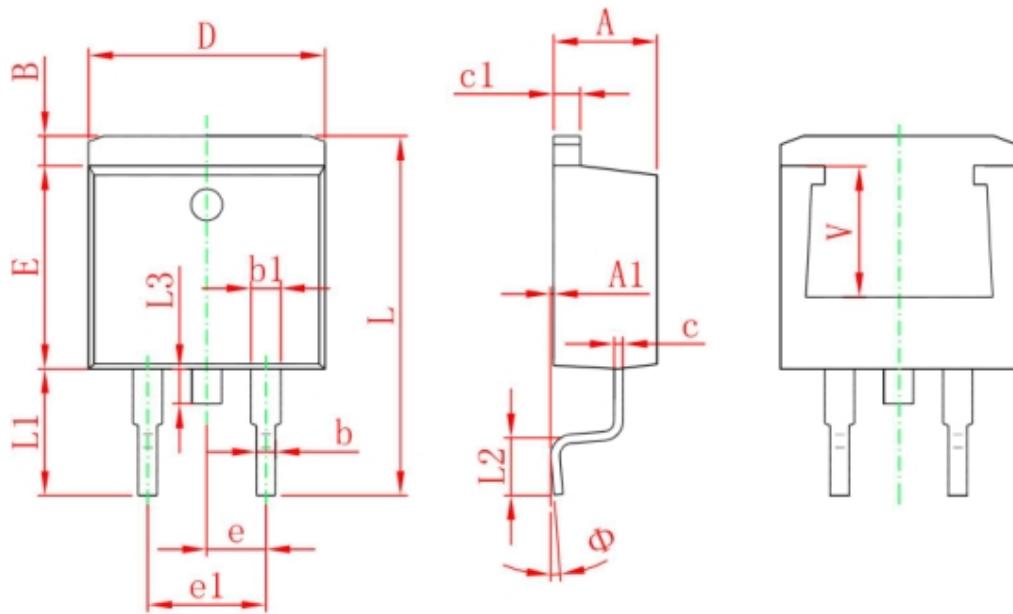


Current De-rating



Normalized Maximum Transient Thermal Impedance

TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
Φ	0°	8°	0°	8°
V	5.600 REF.		0.220 REF.	